



To: Technology Center: **ISSUE FEES**  
Facsimile Number: **703-746-4000**

From: Robert D. Marshall, Jr.  
Texas Instruments Incorporated  
Facsimile: 972-917-4418  
Phone: 972-917-5290


Total Pages Sent: 5

**IN THE UNITED STATES PATENT AND TRADEMARK OFFICE**

In re the Application of **TI-33252**  
**Shigetoshi Muramatsu, et al.** Art Unit: 2124  
Serial No.: 09/955,138 Examiner: Chuong D. Ngo  
Filed: September 19, 2001 Conf. No.: 8378  
For: Multiple Block Adder Using Carry Increment Adder

**CERTIFICATION OF FACSIMILE TRANSMISSION**

I hereby certify that the following papers are being transmitted by facsimile to the U.S. Patent and Trademark Office at 703-746-4000 on the date shown below:

  
Robin E. Barnum

September 13, 2004  
Date

**FACSIMILE COVER SHEET**

<input checked="" type="checkbox"/> <b>FACSIMILE COVER SHEET</b>	<input checked="" type="checkbox"/> <b>AMENDMENT</b> <u>312</u> (1 Page)
<input type="checkbox"/> NEW APPLICATION	<input type="checkbox"/> EOT <u>(# Pages)</u>
<input type="checkbox"/> DECLARATION (# Pages)	<input type="checkbox"/> NOTICE OF APPEAL (# Pages)
<input type="checkbox"/> ASSIGNMENT (# Pages)	<input type="checkbox"/> APPEAL <u>(# Pages)</u>
<input type="checkbox"/> FORMAL DRAWINGS	<input checked="" type="checkbox"/> <b>ISSUE FEE (1 Page)</b>
<input type="checkbox"/> INFORMAL DRAWINGS	<input type="checkbox"/> REPLY BRIEF (IN TRIPLICATE) (# Pages)
<input type="checkbox"/> CONTINUATION APP'N (# Pages)	<input checked="" type="checkbox"/> <b>Page 1 of As Filed Specification (1 page)</b>
<input type="checkbox"/> DIVISIONAL APP'N	<input type="checkbox"/> <b>Page 1 of Filing Receipt (1 page) [COPY]</b>
<b>NAME OF INVENTOR(S):</b> Shigetoshi Muramatsu, et al.	
<b>TITLE OF INVENTION:</b> Multiple Block Adder Using Carry Increment Adder	
<b>TI FILE NO.:</b> TI-33252	<b>DEPOSIT ACCT. NO.:</b> 20-0668
<b>FAXED:</b> 9/13/04	
<b>DUE:</b> 11/26/04	
<b>ATTY/SECY:</b> RDM/reb	
<b>Serial No.:</b> 09/955,138	
<b>Filing Date:</b> September 19, 2001	

This facsimile is intended only for the use of the address named and contains legally privileged and/or confidential information. If you are not the intended recipient of this telecopy, you are hereby notified that any dissemination, distribution, copying or use of this communication is strictly prohibited. Applicable privileges are not waived by virtue of the document having been transmitted by Facsimile. Any misdirected facsimiles should be returned to the sender by mail at the address indicated on this cover sheet.

Texas Instruments Incorporated  
PO Box 655474, M/S 3999  
Dallas, TX 75265